

Declaration and Power of Attorney for Patent Application

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name: I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled: **METHOD AND STRUCTURE FOR COOLING A DUAL CHIP MODULE WITH ONE HIGH POWER CHIP**

the specification of which (check one)



is attached hereto.



was filed on _____ as Application Serial No. _____ and was amended on _____.

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the patentability of this application in accordance with Title 37, Code of Federal Regulations, §1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, §119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s):

Number	Country	Day/Month/Year	Priority Claimed
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I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose information material to the patentability of this application as defined in Title 37, Code of Federal Regulations, §1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

Prior U.S. Applications:

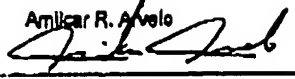
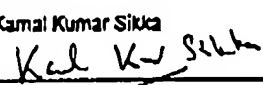

Serial No.	Filing Date	Status
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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

As a named inventor, I hereby appoint the following attorneys and/or agents to prosecute this application and transact all business in the Patent and Trademark Office connected therewith: Joseph P. Abate (Reg. No. 30,238), Jesse Abzug (Reg. No. 31,316), Jay Anderson (Reg. No. 38,371), Ira D. Blocker (Reg. No. 29,894), Steven Capella (Reg. No. 33,086), H. Daniel Schnurmann (Reg. No. 35,791), Tiffany Townsend, (Reg. No. P-43,199), William P. Skadony (Reg. No. 33,787), Anthony N. Magistrale (Reg. No. 35,595), Harold Huberfeld (Reg. No. 26,665), Todd M.C. Li (Reg. No. 45,554), Margaret A. Pepper (Reg. No. 45,008), Stanley B. Green (Reg. No. 24,351), Christopher A. Hughes (Reg. No. 26,914), John E. Hoel (Reg. No. 26,279), Joseph C. Redmond, Jr. (Reg. No. 18,753), Eugene I. Shkurko (Reg. No. 36,678), Steven Soucar (Reg. No. 32,440), Anthony N. Magistrale (Reg. No. 35,595), Sean M. McGinn (Reg. No. 34, 386), and Frederick W. Gibb, III (Reg. No. 37,629).

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Signature:  09/25/2003
Residence: 97 Autumn Drive, Poughkeepsie, NY 12603
Citizenship: India
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- (3) Inventor: Milton T. Toy
Signature:  9/25/03
Residence: ~~27 Kendall Drive, Wappingers Falls, NY 12590~~
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Citizenship: USA
Post Office Address: Same as residence
-

OATH & ASSIGNMENT

The undersigned, (1) Amilcar R. Arvelo
(2) Kamal Kumar Sikka
(3) Hilton T. Toy

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(2) 97 Autumn Drive, Poughkeepsie, NY 12603
(3) ~~27 Kendall Drive, Wappingers Falls, NY 12590~~
24 Champlain Drive, Hopewell Jn, NY 12533

hereby undertake that the invention/new utility mode/new design entitled:

**METHOD AND STRUCTURE FOR COOLING A DUAL CHIP MODULE WITH ONE
HIGH POWER CHIP**

was truly invented by us. The undersigned agree to accept punishments provided
for in laws in case of any imposture, plagiarism, imitation or deceptive activities.

1. The undersigned hereby assigns all its rights and interests regarding the invention
as far as the Republic of China is concerned to:

International Business Machines Corporation

(hereinafter "Assignee"), a corporation respectfully organized and existing under the laws
of New York, United States of America

and located at New Orchard Road, Armonk, New York 10504, United States of
America

and do hereby declare that the Assignee is entitled to apply for and obtain patent rights on
the invention in its own name in the Republic of China.

Signature(s)



Amilcar R. Arvelo

Kamal K. Sikka

Kamal Kumar Sikka

Hilton T. Toy

Hilton T. Toy

Date

09/25/03

09/25/2003

9/25/03